

(V) Preliminary Specifications () Final Specifications

Module	11.6"(11.57") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B116XW03 V1 (H/W:0A)
Note (🗭)	LED Backlight with driving circuit design

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ite: This Specification is s hout notice.	ubject to change	NBBU Market AU Optronics	_

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Contents

1. Handling Precautions	5
2. General Description	
2.1 General Specification	6
2.2 Optical Characteristics	
3. Functional Block Diagram	
4. Absolute Maximum Ratings	
4.1 Absolute Ratings of TFT LCD Module	13
4.2 Absolute Ratings of Environment	
5. Electrical Characteristics	14
5.1 TFT LCD Module	14
5.2 Backlight Unit	16
6. Signal Interface Characteristic	17
6.1 Pixel Format Image	
6.2 The Input Data Format	18
6.3 Integration Interface Requirement	19
6.4 Interface Timing	
7. Panel Reliability Test	
7.1 Vibration Test	
7.2 Shock Test	23
7.3 Reliability Test	23
8. Mechanical Characteristics	2 4
8.1 LCM Outline Dimension	24
9. Shipping and Package	26
9.1 Shipping Label Format	26
9.2 Carton Package	27
9.3 Shipping Package of Palletizing Sequence	
10 Annendix: FDID Description	



Record of Revision

Vei	rsion and Date	Page	(Old des	cription	on			New D)escrip	tion		Remark
0.1	2009/01/07	All	First Edition	n for Ci	ustom	er							
0.2	2009/02/13	13	VDD Power	r:1.6W	(max))		VDD Power:0.8W (max)				modified	
		29,	LCM Outline	Dimer	sion:			LCM Outline Dimension:				modified	
		30	Y diemensio	n is 17	3mm v	ersio	n.	Y dimension shorter.					
		20 30	LVDS Conr	nector F	Postio	n:90.	38	LVDS Co	LVDS Connector Postion:99.2				modified
0.3	2009/03/05	5	Physical Siz	е				Physical S	Size				modified
			N	∕lin.	Тур.		Иах.		Min.	Тур.	Ma		
				74.5	275.0		75.5	Length	277.5	278			
				71.0	172.0		73.0	Width	166	167	16		
		19	LED enable	pin(+3\	/ Input	t)		LED enab	ole pin(+	3.3±0.3	V Input)		modified
		13	IDD Current	Specifi	cation			IDD Curre		cification			typo
			Symble		yp		Max	Symble	e	Тур	Ma		
			IDD	-	50	4	450	IDD		242	26	57	
0.4	2009/03/16	6	Response ⁻					Respons	e Time				Updated
			Rising: TBI	O(typ),	TBD(r	max)		Rising: 6	ms(typ)	, 8ms(r	nax)		
			Falling: TBI	D(typ),	TBD(max)		Falling: 2	ms(typ), 4ms(ı	max)		
		15	LED Power	Consu	ımptio	n		LED Pow	er Con	sumptic	n	1	Updated
				Тур		Max	Unit			Тур	Max	Unit	
			LED Power consumption	TBD)	TBD	Walt	LED Powe consumpti		3.01	3.06	Walt	
		22	Timing Cha	ırateris	tics: T	BD		Timing C	harater	istics: l	Jpdated	k	Updated
		31	Shipping La	bel Fori	mat: T	BD		Shipping	Label Fo	ormat: A	dded		Updated
		32	Carton pack	age:TB	D			Carton pa	ickage:	Added			Updated
		33	Shipping pa	•	of palle	etizing		Shipping sequence			etizing		Updated
		6	Color / Chro	maticity	/ Cood	dinates	s: TBD	Color / Ch	nromatic	ity Coo	dinates:	Added	Updated
0.5	2009/6/3	6	Screen Diag	onal: 1	1.6"			Screen D	iagonal	: 293.8	(mm)		Update
			Response t	ime: 12	2 (ma:	x)		Respons	e time:	16 (ma	x)		Update
		7	Response t									Update	
			Conditions	Min.	Тур	. M	ax.	Condition	s Min	. Тур	. Max		
			Rising	-	6		8	Rising	-	3	-		
			Falling	-	2		4	Falling	_	5	_		
			Rising + Falling	_	8		12	Rising +	l l		1.0		
			i aiiiiy		1 0		· -	Falling		8	16		



		14	5.1.1 Power	Spec	ificatio	n							Update
			Parameter	Min	Тур	Max	Units	Parameter	Min	Тур	Max	Units	
			IDD Current	-	350	450	[mA]	IDD Current	-	-	450	[mA]	
		16						5.2.1 LED o	charac	cteristi	cs		add
		16							ight ir tics (t	nput si able)	gnal		Table Update
		21	6.4.1 Timin	6.4.1 Timing Characteristics			6.4.1 Timin	g Cha	aracter	ristics		Table Update	
1.0	2009/6/4		Final spec	-inal spec									
1.1	2009/12/6	6	Update pov	ver co	nsum	otion		Total power	r cons	sumpti	on 2.9	W max	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



2. General Description

B116XW03 V1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B116XW03 V1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

[mm]	293.8 256.125 X 1 1366x3(RG 0.1875 x 0.1				
	1366x3(RG				
[mm]	,	B) x 768			
[mm]	0 1875 x 0				
	0.1070 X 0.	1875			
	R.G.B. Vert	ical Stripe			
	Normally W	hite			
[cd/m ²]			• /		
	1.25 max. (5 points)			
	500 typ				
[ms]	8 typ / 16 M	lax			
[Volt]	+3.3 typ.				
[Watt]	2.9 max. (Ir	clude Logic	and BLU po	ower)	
[Grams]	235 max.				
[mm]		Min.	Тур.	Max.	
	Length	277.5	278.0	278.5	
	Width	167.5	168.0	168.5	
	Thickness	-	-	3.6	
	1 channel L	VDS			
[mm]	0.5				
	Anti-Glare,				
	262K colors	(RGB 6-bi	t)		
	[cd/m²] [ms] [Volt] [Watt] Grams] [mm]	R.G.B. Vert Normally W	R.G.B. Vertical Stripe Normally White [cd/m²] 200 typ. (5 points averal 180 min. (5 points averal 1.25 max. (5 points) 500 typ [ms] 8 typ / 16 Max [Volt] +3.3 typ. [Watt] 2.9 max. (Include Logic Grams] 235 max. [mm] Min. Length 277.5 Width 167.5 Thickness - 1 channel LVDS [mm] 0.5 Anti-Glare,	R.G.B. Vertical Stripe Normally White	



Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

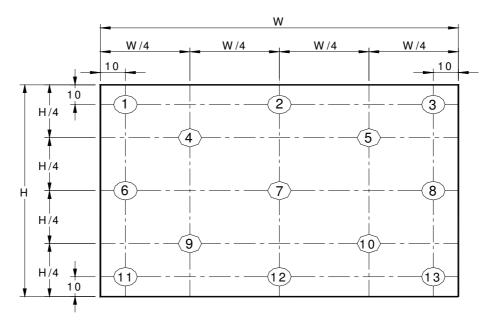
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Lumir			5 points average	180	200	-	cd/m ²	1, 4, 5.
Viewing Ar	aglo	θR θL	Horizontal (Right) CR = 10 (Left)	40 40	45 45	-	degree	
viewing Ai	igie	ф н ф ∟	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	-		4, 9
Luminan Uniformi		δ _{5P}	5 Points	-	-	1.25		1, 3, 4
Luminan Uniformi		δ _{13P}	13 Points	-	-	1.50		2, 3, 4
Contrast R	Contrast Ratio			400	500	-		4, 6
Cross ta	lk	%				4		4, 7
		Tr	Rising	-	3	-		
Response 7	Гime	T_f	Falling	-	5	-	msec	4, 8
		T _{RT}	Rising + Falling	-	8	16		
	Red	Rx		0.554	0.584	0.614		
	neu	Ry		0.303	0.333	0.363		
	Green	Gx		0.308	0.338	0.368		
Color / Chromaticity	Green	Gy		0.541	0.571	0.601		
Coodinates	Blue	Вх	CIE 1931	0.128	0.158	0.188		4
	Diue	Ву		0.103	0.133	0.163		
	White	Wx		0.283	0.313	0.343		
	wille	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

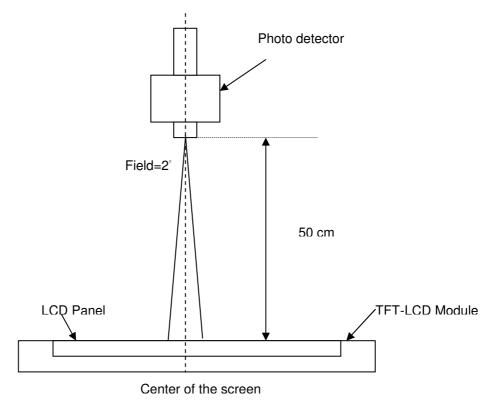
2	_	Maximum Brightness of five points
δ w5	=	Minimum Brightness of five points
2	_	Maximum Brightness of thirteen points
δ w13	= '	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

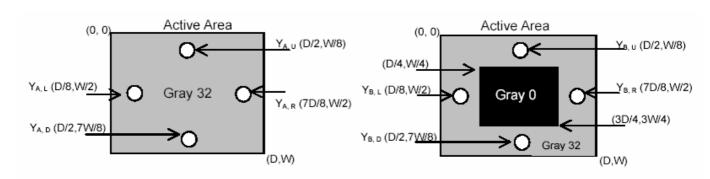
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

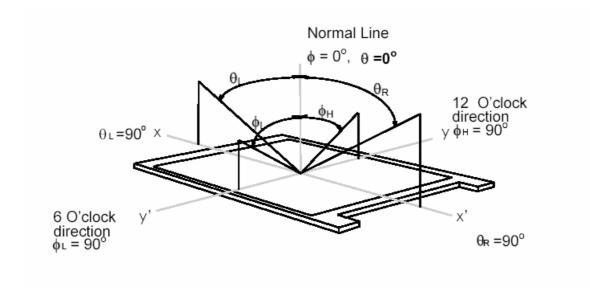




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Note 9. Definition of viewing angle

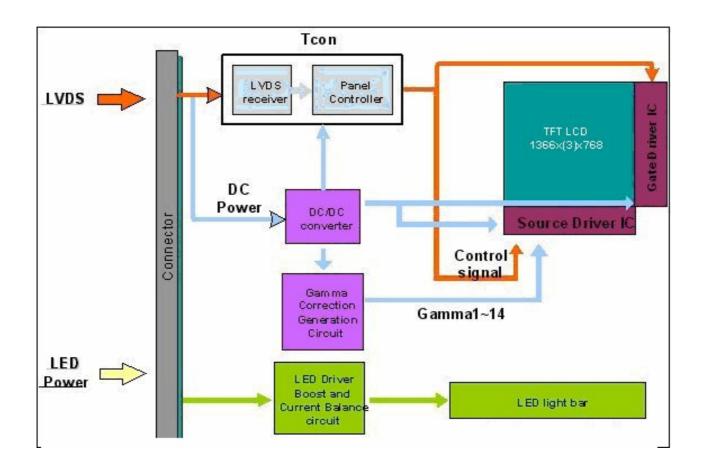
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 11.6 inches wide Color TFT/LCD 40 Pin one channel Module





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

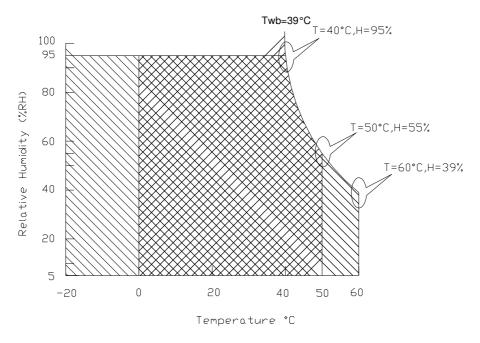
	<u> </u>				
Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

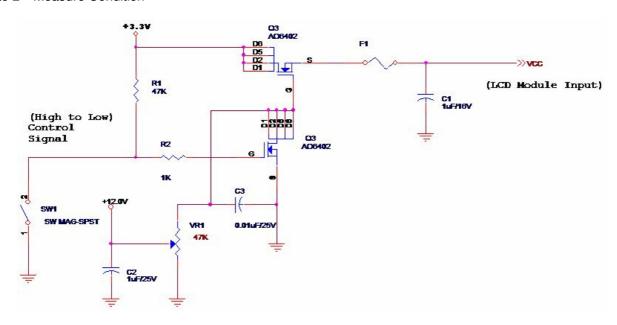
Input power specifications are as follows;

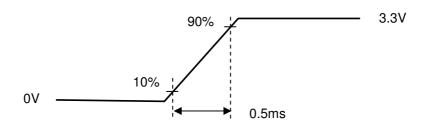
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	-	0.8	[Watt]	Note 1
IDD	IDD Current	-	-	242	[mA]	Note 1
lRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern at 3.3V driving voltage. (P_{max}=V_{3.3} x I_{black})

Note 2: Measure Condition





Vin rising time



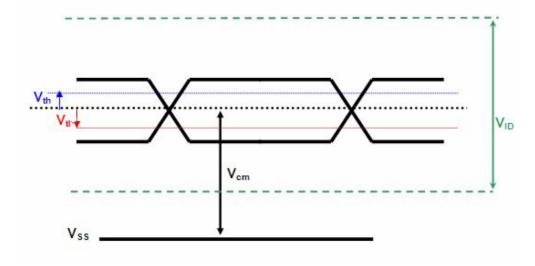
5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V_{th}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{tl}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{cm}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	2.08	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25°C), Note 2
						I _F =20 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VIED EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	Define as
PWM Logic Input High Level	VPWM EN	2.5	-	5.5	[Volt]	Connector Interface
PWM Logic Input Low Level	_	-	-	0.8	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	900	-	1.1k	Hz	
PWM Duty Ratio	Duty	5		100	%	



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1						13	66
1st Line	R G B	R G B		R	G	В	R	G B
	'		1					:
	•		1		•			
		,	•					:
			•					:
			•		•			.
	'	' '	1					;
		,						:
					_			
768th Line	R G B	R G B		R	G	В	R	G B



6.2 The Input Data Format

RxCLKIN		/
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1
RxIN2	DE VS HS B5 B4	B3 B2

Cianal Nama	Description	
Signal Name	Description (MCD)	Dad aired Data
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
	·	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
D -	Green-pixel Data	5
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
IIAOLININ	Data Ciuck	DE signals. All pixel data shall be valid at the
DE	Dioplay Timing	falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
VC	Vartical Cura	data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20455-040E-12 or compatible
Mating Housing/Part Number	IPEX 20353-040T-11 or compatible

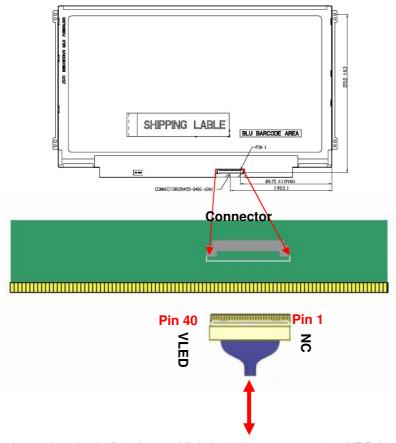
6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description
1	NC	No Connection (Reserve)
2	VDD	Power Supply +3.3V
3	VDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	NC	No Connect (Reserve)
6	CLK_EDID	EDID Clock Input
7	DAT_EDID	EDID Data Input
8	RxOIN0-	-LVDS Differential Data INPUT(Odd R0-R5,G0)
9	RxOIN0+	+LVDS Differential Data INPUT(Odd R0-R5,G0)
10	VSS	Ground
11	RxOIN1-	-LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
12	RxOIN1+	+LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
13	VSS	Ground
14	RxOIN2-	-LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
15	RxOIN2+	+LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
16	VSS	Ground
17	RxOCKIN-	-LVDS Odd Differential Clock INPUT
18	RxOCKIN+	-LVDS Odd Differential Clock INPUT
19	IMG_EN	Color Matrix Enable (3.0V~3.6V,3.3V type)
20	NC	No connection
21	NC	No connection
22	NC	No connection



	1	
23	NC	No connection
24	NC	No connection
25	NC	No connection
26	NC	No connection
27	NC	No connection
28	NC	No connection
29	NC	No connection
30	NC	No connection
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	VPWM_EN	PWM logic input level
36	VLED_EN	LED enable input level
37	DCR_EN	DCR Enable(3.0V~3.6V, 3.3V type)
38	VLED	LED Power Supply
39	VLED	LED Power Supply



Note1: Input signals shall be low or High-impedance state when VDD is off.



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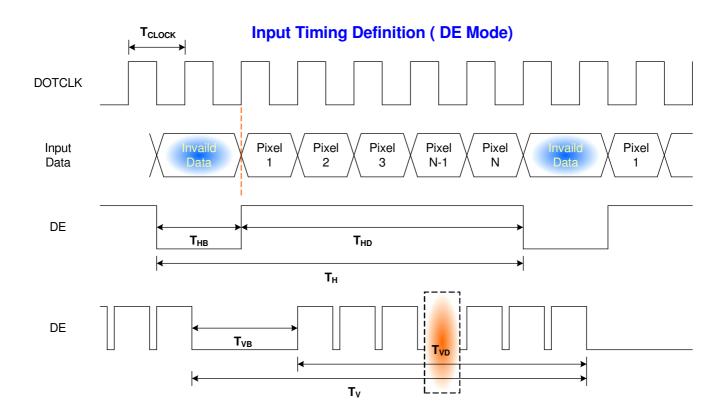
6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-		60	-	Hz
Clock fr	equency	1/ T _{Clock}	65	69.3	80	MHz
	Period	T _V	776	793	1000	
Vertical	Active	T _{VD}	768		T_Line	
Section	Blanking	T _{VB}	8	25	180	
	Period	T _H	1396	1456	2000	
Horizontal	Active	T _{HD}		1366		T _{Clock}
Section	Blanking	T _{HB}	30	90	634	

Note: DE mode only

6.4.2 Timing diagram



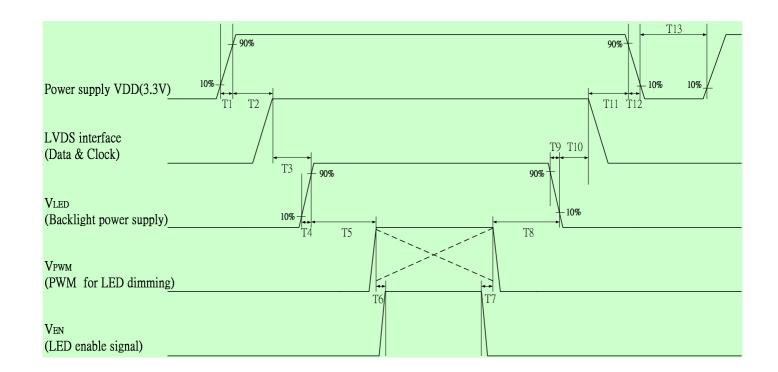
B116XW01 V1 __Document Version : 1.1 21 of 30



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6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



	Power Sequence Timing						
	Value						
Parameter	Min.	Тур.	Max.	Units			
T1	0.5	-	10				
T2	0	-	50				
Т3	200	-	-				
Т4	0.5	-	10				
T5	10	-	-				
Т6	10	-	-				
Т7	0	-	-	ms			
Т8	10	-	-				
Т9	0	-	10				
T10	200	-	-				
T11	0.5	-	50				
T12	0	-	10				
T13	400	-	-				

Note:If T3,T5,T6 couldn't match above specifications, must request <u>T3+T5+T6 > 200ms</u> at least



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

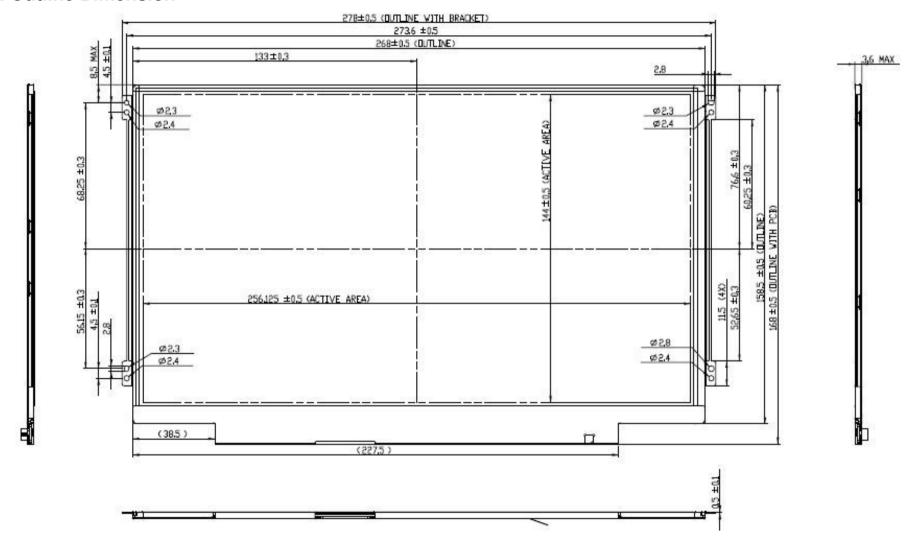
23 of 30



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8. Mechanical Characteristics

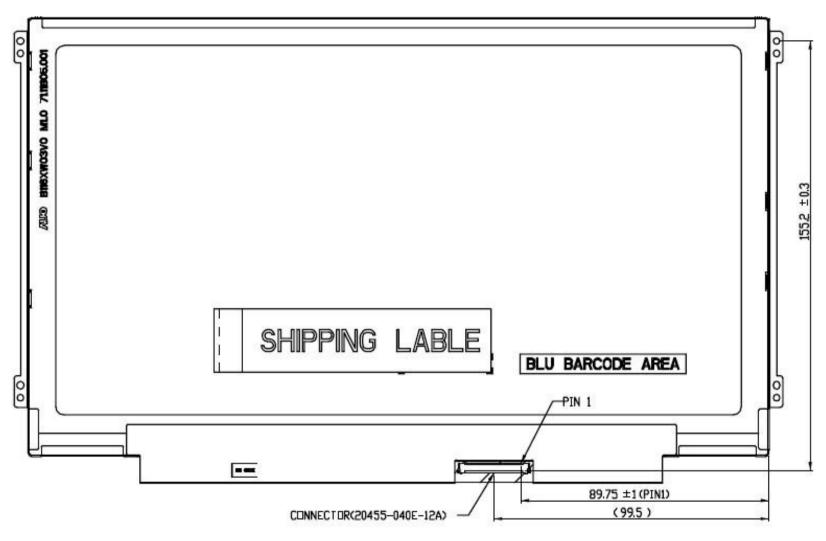
8.1 LCM Outline Dimension



B116XW01 V1 Document Version : 1.1 24 of 30



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Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

B116XW01 V1 _Document Version : 1.1 25 of 30

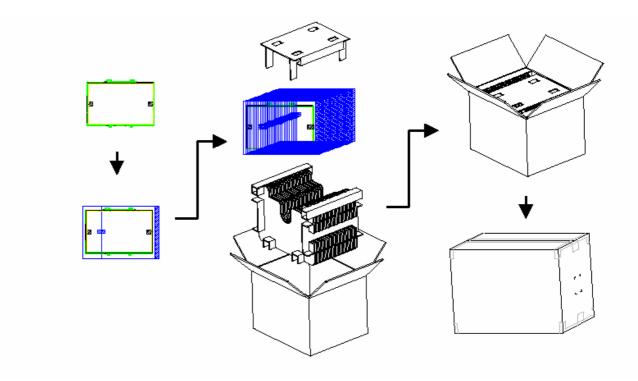


- 9. Shipping and Package
- 9.1 Shipping Label Format

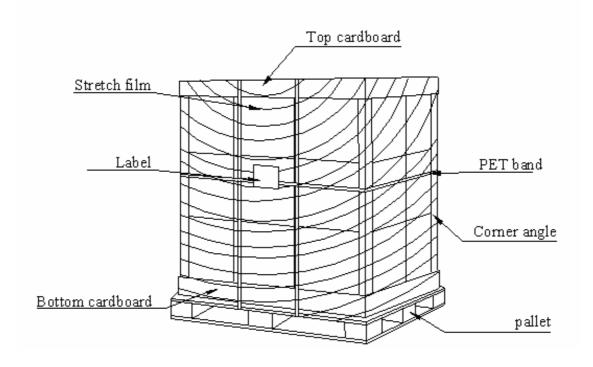
(TBD)



The outside dimension of carton is 469(L)mm* 378(W)mm* 266(H)mm



9.3 Shipping Package of Palletizing Sequence





10. Appendix: EDID Description

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